



Since its first edition in 2005, IEEE DySPAN has grown to become the flagship international conference that addresses innovative approaches to radio spectrum access and management. The unique blend of technology and policy topics, focusing on the development, deployment, and regulation of dynamic spectrum access networks, as well as special efforts to bring the policy and technology communities together in a single event, are trademarks of IEEE DySPAN that have led to significant insights and broader impact on the field.

For 2017, IEEE DySPAN comes back where it all began - Baltimore, Maryland, USA. The conference promises to bring an exciting research program and unique forum for practitioners, researchers, and policymakers. The setting will provide cultural experiences, restaurants to satisfy every palate, family-friendly museums, and exciting nightlife.

Technology Program	Policy Program
<ul style="list-style-type: none"> • Dynamic spectrum access for extremely high-frequency (mmWave) spectrum • Spectrum management for the Internet of Things • Licensed Shared Access and secondary use of government spectrum bands • Pricing and access rules for secondary spectrum • RF energy harvesting in dynamic spectrum access regimes • Low-power dynamic spectrum access • Long-term experimental results of dynamic spectrum access systems • Robust simulation methods and validation models of dynamic spectrum access systems • Dynamic spectrum access for underserved regions 	<ul style="list-style-type: none"> • Market and regulatory approaches to spectrum allocation, management, and/or sharing given rapidly changing technology • Spectrum management policies and tools for emerging 5G systems • Monitoring, enforcing, and implementing of spectrum access systems and policies • Frameworks appropriate for bidirectional sharing • Definitions of spectrum efficiency for policymakers • First responder communications or public safety mobile broadband (e.g. FirstNet) deployment • Spectrally and economically efficient spectrum sharing

Accepted and presented papers will be published in the IEEE DySPAN 2017 Conference Proceedings and submitted to IEEE Xplore®. Full details of submission procedures and requirements for authors of accepted papers are available at <http://dyspan2017.ieee-dyspan.org>.

Important Dates

Paper Submission Deadline
October 15, 2016

Rebuttal Phase
12-14 December 2016

Notification of Acceptance
15 January 2017

Committee

General Chairs
Matthew Hussey, FCC
J. Nicholas Laneman, University of Notre Dame

Technology Program Chairs
Przemysław Pawełczak, TU Delft
Ralf Bendlin, Intel

Policy Program Chairs
Guilia McHenry, NTIA
Martin Weiss, University of Pittsburgh